

Product Summary

V_{(BR)DSS}	Max R_{DS(on)}	Max I_D T_A = +25°C
-100V	8Ω @ V _{GS} = 10V	-310mA

Features and Benefits

- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

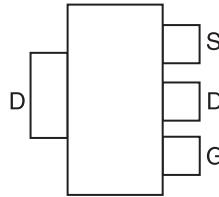
Mechanical Data

- Case: SOT223
- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See Diagram Below
- Terminals: Finish - Matte Tin Annealed over Copper Leadframe; Solderable per MIL-STD-202, Method 208 ③
- Weight: 0.112 grams (Approximate)

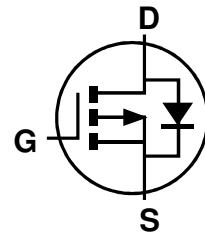
SOT223



Top View



Pin Out Top-View



Equivalent Circuit

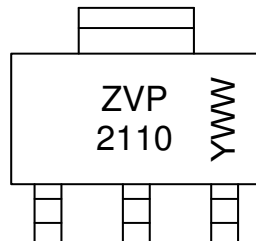
Ordering Information (Note 4)

Part Number	Compliance	Case	Packaging
ZVP2110GTA	Standard	SOT223	1,000

- Notes:
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information

SOT223



ZVP 2110 = Product Type Marking Code
 YWW = Date Code Marking
 Y or \bar{Y} = Last Digit of Year (ex: 5= 2015)
 WW or $\bar{W}W$ = Week Code (01~53)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Drain-Source Voltage	V _{DS}	-100	V
Gate-Source Voltage	V _{GS}	±20	V
Continuous Drain Current	I _D	-310	mA
Pulsed Drain Current	I _{DM}	-3	A

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

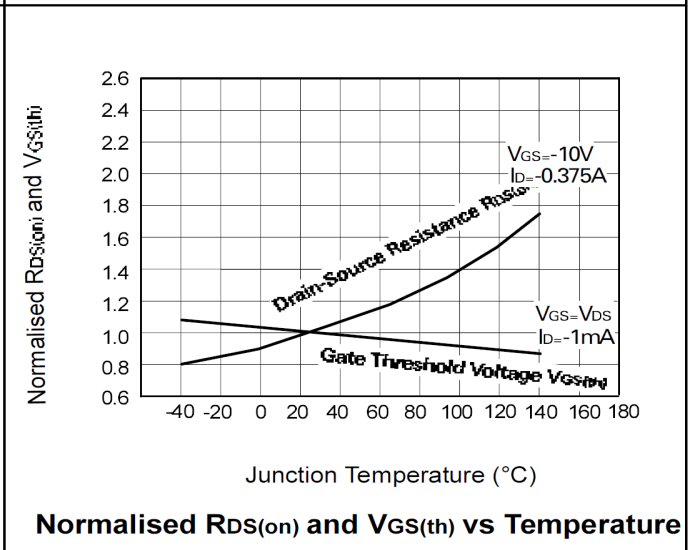
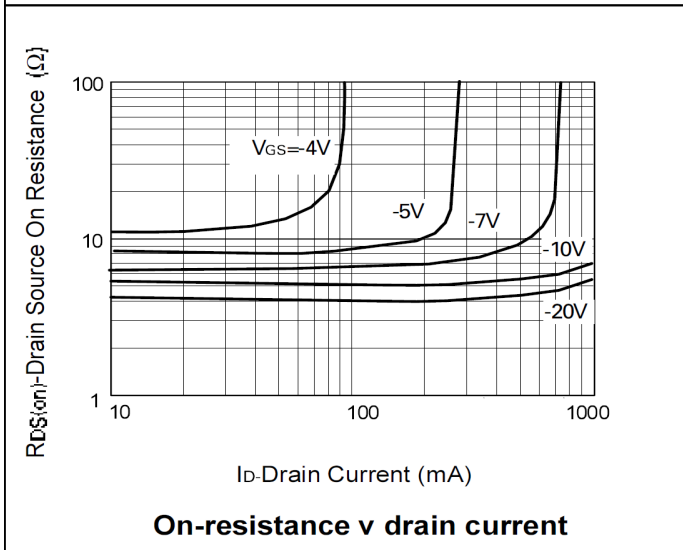
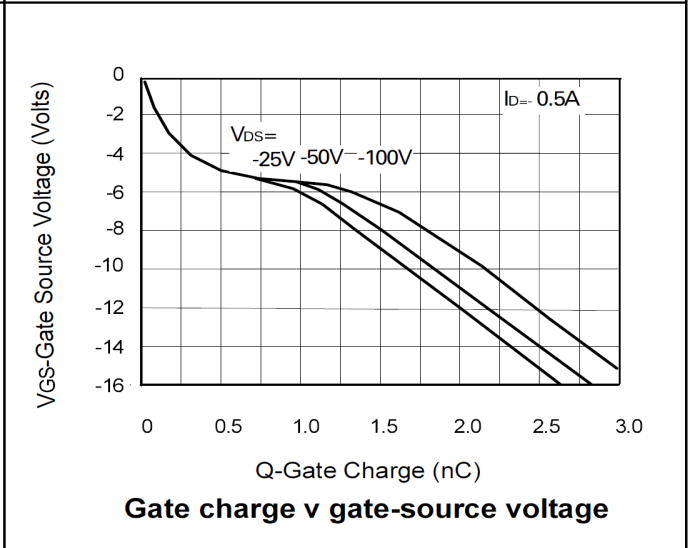
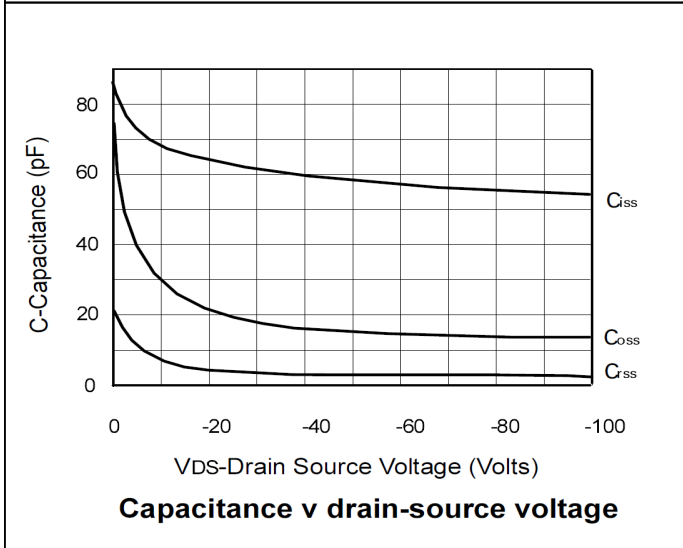
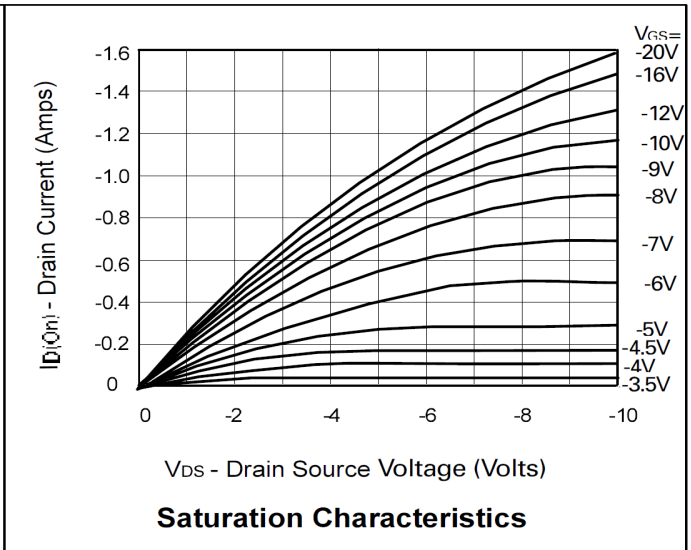
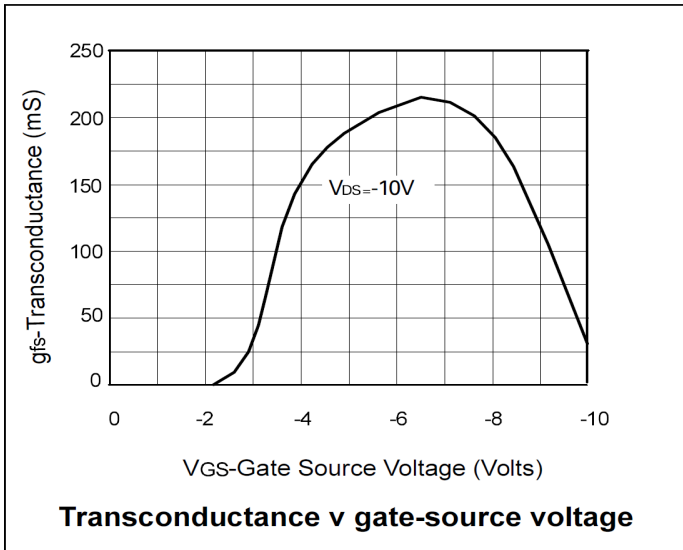
Characteristic	Symbol	Value	Unit
Power Dissipation at T _A = +25°C	P _{tot}	2	W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV _{DSS}	-100	—	—	V	I _D = -1mA, V _{GS} = 0V
Zero Gate Voltage Drain Current	I _{DSS}	—	—	-1 -100	μA	V _{DS} = -100V, V _{GS} = 0V V _{DS} = -80V, V _{GS} = 0V, T = +125°C (Notes 6)
Gate-Body Leakage	I _{GSS}	—	—	-20	nA	V _{GS} = ±20V, V _{DS} = 0V
Gate-Source Threshold Voltage	V _{GS(th)}	-1.5	—	-3.5	V	I _D = -1mA, V _{DS} = V _{GS}
ON CHARACTERISTICS						
On-State Drain Current (Note 5)	I _{D(on)}	-750	—	—	mA	V _{DS} = -25V, V _{GS} = -10V
Static Drain-Source On-State Resistance (Note 5)	R _{DS(ON)}	—	—	8	Ω	V _{GS} = -10V, I _D = -375mA
Forward Transconductance (Notes 5 & 6)	g _{fs}	125	—	—	mS	V _{DS} = -25V, I _D = -375mA
DYNAMIC CHARACTERISTICS						
Input Capacitance (Note 6)	C _{iss}	—	—	100	pF	V _{DS} = -25V, V _{GS} = 0V f = 1MHz
Output Capacitance (Note 6)	C _{oss}	—	—	35	pF	
Reverse Transfer Capacitance (Note 6)	C _{rss}	—	—	10	pF	
Turn-On Delay Time (Notes 6 & 7)	t _{d(on)}	—	—	7	ns	V _{DD} ≈ -25V, I _D = -375mA
Turn-On Rise Time (Notes 6 & 7)	t _r	—	—	15	ns	
Turn-Off Delay Time (Notes 6 & 7)	t _{d(off)}	—	—	12	Ns	
Turn-Off Fall Time (Notes 6 & 7)	t _f	—	—	15	Ns	

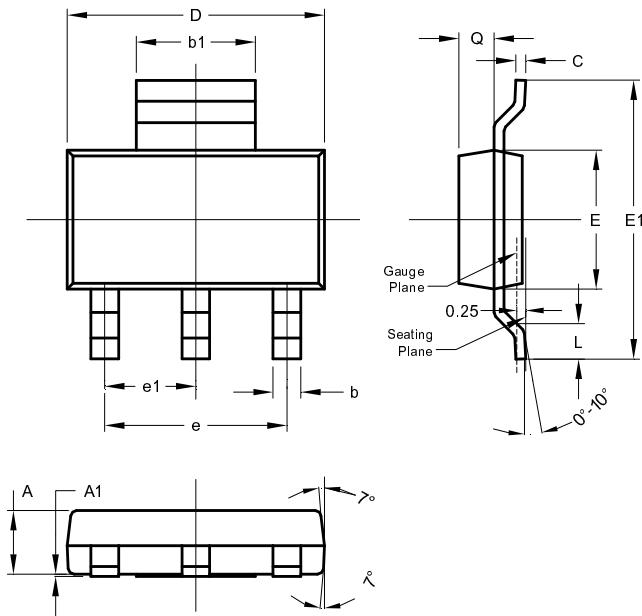
- Notes:
5. Measured under pulsed conditions. Width = 300μs. Duty cycle ≤ 2%.
 6. Sample Test.
 7. Switching times measured with 50Ω source impedance and <5ns rise time on a pulse generator.

Typical Characteristics



Package Outline Dimensions

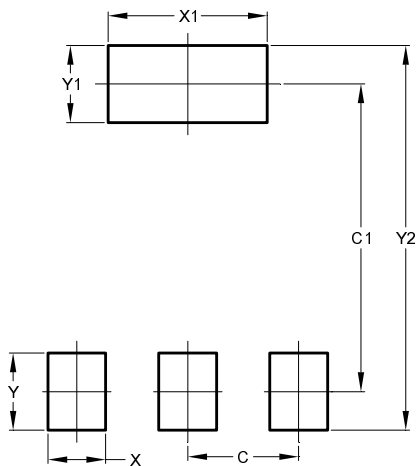
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.



SOT223			
Dim	Min	Max	Typ
A	1.55	1.65	1.60
A1	0.010	0.15	0.05
b	0.60	0.80	0.70
b1	2.90	3.10	3.00
C	0.20	0.30	0.25
D	6.45	6.55	6.50
E	3.45	3.55	3.50
E1	6.90	7.10	7.00
e	-	-	4.60
e1	-	-	2.30
L	0.85	1.05	0.95
Q	0.84	0.94	0.89
All Dimensions in mm			

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
C	2.30
C1	6.40
X	1.20
X1	3.30
Y	1.60
Y1	1.60
C2	8.00

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